

# **NEREID**

# H2020-ICT-CSA: Micro- and Nano-Electronics Technologies Grant Agreement n° 685559

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# 11<sup>th</sup> MOS AK Workshop

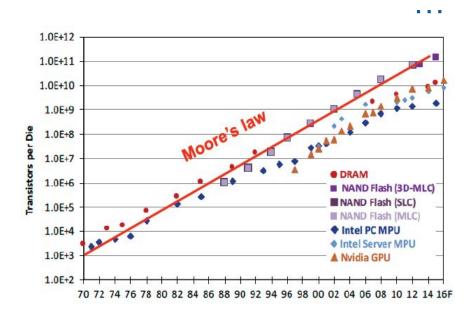
Silicon Valley, December 5, 2018

**Title**: NanoElectronics Roadmap for Europe: Identification and Dissemination



# NEREID Roadmap based on a change of paradigm

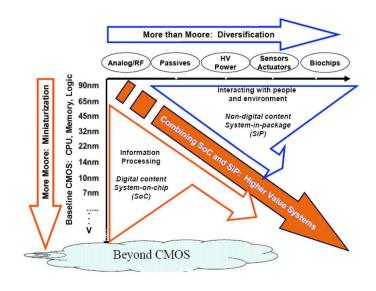
#### From More Moore ... ... to



- From device density ... ... to ...
- ... to ... • From device cost driven ...
- From single figure of merit ... to ...
- From Technology push ... ... to ... Application pull

... full supply chain ... sustainability

# More than Moore and heterogeneous integration



... functionality increase

... system cost driven

... multiple parameters



# **Aim of NEREID Roadmap**

-to take into account the specificity of the European industrial and academic landscape and European applications needs

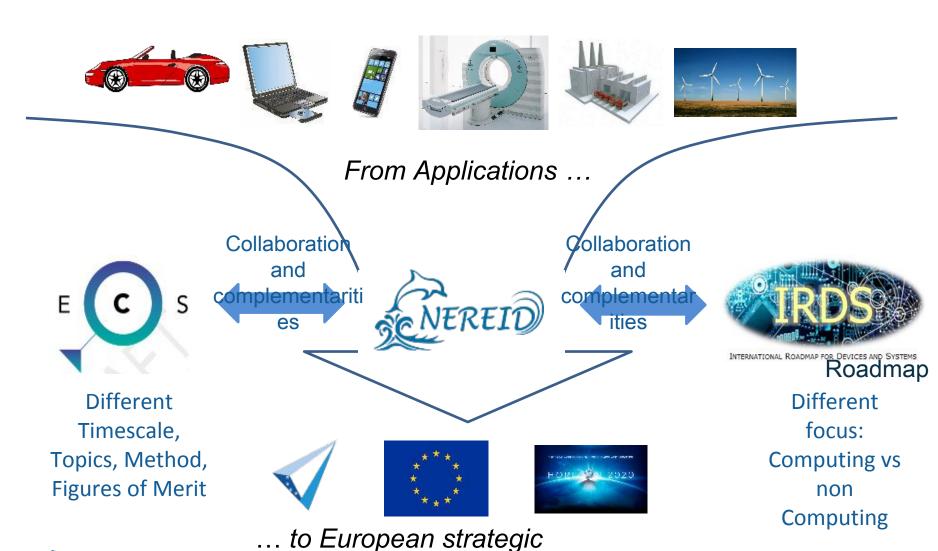
### -to be used:

- as input for research programmes of European and national organizations
- to better coordinate academic and industrial research
- For equipment, semiconductors and application development.



# **NEREID Roadmap Flow**

programs





## **NEREID Structure & coordination with other regions**

Dissemination Management 8 Communication **Beyond CMOS** 

Advanced Logic and Connectivity

**Functional diversification** 

System Design & Heterogeneous Integration

Equipment & Manufacturing Science

Coordination with roadmap initiatives

**Advisory Committee** 



10-15 high level members: Europe, USA, Asia



# NEREID: Tasks and Topics



WP	Work Package	Tasks	
1	Management (INP, SINANO)	1. 1 Coordination (Grenoble INP)	
		1.2 Technical Management (SINANO Institute)	
2	Beyond CMOS (VTT)	2.1 Emerging devices (VTT)	
		2.2 Computing paradigms (ICN2)	
3	Advanced Logic & Connectivity (imec)	3.1 Nanoscale FET (INP)	
		3.2 Connectivity (LETI)	
4	Functional Diversification (LETI)	4.1 Smart sensor (EPFL)	
		4.2 Smart Energy (IUNET)	
5	System Design & Heter. Integr. (PoliTo)	5.1 System Design (PoliTo)	
		5.2 Heterogeneous Integration (Tyndall)	
6	Equipm. & Manufact. Science (FhG)	6.1 Equipment and Materials (imec)	
		6.2 Manufacturing Science (FhG)	
7	Communication & Dissemination (EDAcentrum)	7.1 Set-up of web node and comm. Tools (ECN)	
		7.2 Planning of Dissemination events (ECN)	
8	Coordination with roadmap initiatives (EPFL)	Advisory Board	

# NEREID: Industrial co-Leaders

WP	Description	Industrial co-leaders
WP1	Management	AENEAS
WP2	Beyond CMOS	IBM Zurich
WP3	Advanced Logic and Connectivity	STMicroelectronics
	Functional diversification	Infineon (Smart Energy)
WP4		NXP (Smart Sensors)
WP5	System Design & Heterogeneous Integration	Infineon
		ASML & ASMI (Equipments)
WP6	Equipment & Manufacturing Science	STMicroelectronics (Manufacturing)
WP7	Communication & Dissemination	AENEAS
WP8	Coordination with roadmap initiatives	



# Format of the Roadmap

## **Application requirements**

Short term

## Medium term:

Performance of function or technology, or novel functionality

Convergence

Planned Technology evolution based on extrapolation of present SoA at ≠ TRLs

Value of technological FoM or novel functionality

## Long term:

Performance of function or technology, or novel functionality



Other disruptive Applications based on

No technological solution

# **NEREID Roadmap Status**

## -Organisation of 3 General Workshops:

- ⇒ Application and Technology Experts (> 100)
- => April 2016, Grenoble; April 2017, Athens; June 2018, Sardinia

## -Organisation of many Domain(s) Workshops:

=> Technology Experts for given Task(s)/WP(s)

- -3 International (US, Asia, EU) Advisory Boards
- -Collaboration with other International Roadmaps
- -Many dissemination activities:
  - Conferences, web site, leaflets, posters, newsletters, Press

# **Status of NEREID Roadmap**

-Presentation of highlights of the NEREID Roadmap with the Long Term Vision of the ECS SRA at EFECS, Lisbon, on November 21<sup>st</sup>

-Presentation of some highlights in 3 Speaker Corners at EFECS on November 22<sup>nd</sup>:

-Preparation of 1st European IRDS Workshop and Conference, Grenoble-Minatec, April 3-5, 2019, you are invited to attend the Meeting!



<sup>\*</sup>New Paradigms and Technologies for edge computing in future AI applications (Nov.22, 13:20)

<sup>\*</sup>Smart Energy for power applications and autonomous IOT systems (Nov. 22, 13:00)

<sup>\*</sup>System Design and Heterogeneous Integration (Nov. 22, 10:30)

# **Status of NEREID Roadmap**

Prefinal Roadmap available on:

https://www.nereid-h2020.eu/roadmap

NEREID roadmap introduction, recommendation and conclusion

Advanced Logic and Connectivity -- Nanoscale FETs (T3.1)

<u>Advanced Logic and Connectivity -- Connectivity (T3.2)</u>

Functional Diversification (WP4) -- Smart Sensors (T4.1)

<u>Functional Diversification (WP4) -- Smart Energy (T4.2)</u>

Functional Diversification (WP4) -- Energy for autonomous systems

**T4.2)** 

System Design and Heterogeneous Integration (WP5)

**Beyond CMOS (WP2)** 

**Equipment and Manufacturing Science (WP6)** 





# A fruitful European and International collaboration has been developed in NEREID during 3 years leading to a meaningful Roadmap for the EU

# Thank you!

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